

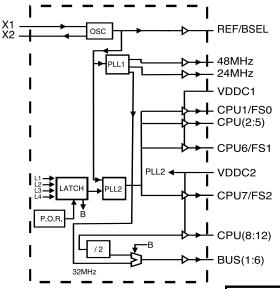
Frequency Generator for Pentium[™] Based Systems

General Description

The **ICS9169C-272** is a low-cost frequency generator designed specifically for Pentium based chip set systems. The integrated buffer minimizes skew and provides all the clocks required. A 14.318 MHz XTAL oscillator provides the reference clock to generate standard Pentium frequencies. The CPU clock makes gradual frequency transitions without violating the PLL timing of internal microprocessor clock multipliers. A raised frequency setting of 68.5MHz is available in the Turbo-mode of the 66.8MHz CPU. The **ICS9169C-272** contains 12 CPU clocks, 4 PCI clocks, 1 REF at 48MHz and 1 at 24MHz.

The twelve CPU clock outputs provide sufficient clocks for the CPU, chip set, memory and up to two DIMM connectors (with four clocks to each DIMM). Either synchronous(CPU/ 2) or asynchronous (32 MHz) PCI busoperation can be selected by latching data on the BSEL input

Block Diagram



VDD Groups: VDD1 = X1, X2, REF/BSEL VDDC1 = CPU1-6 VDDC2 = CPU7-12 & PLL Core VDDB = BUS1-6 VDDF = 48/24 MHz

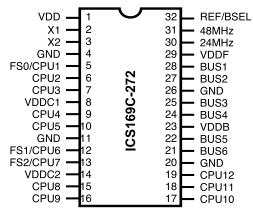
Latched Inputs:

L1 = BSELL2 = FS0L3 = FS1L4 = FS2

Features

- Twelve selectable CPU clocks operate up to 83.3MHz
- Maximum CPU jitter of ± 200 ps
- Six BUS clocks support sync or async bus operation
- 250ps skew window for CPU outputs, 500ps skew window for BUS outputs
- CPU clocks BUS clocks skew 1-4ns (CPU early)
- Integrated buffer outputs drive up to 30pF loads
- 3.0V 3.7V supply range, CPU(1:6) outputs 2.5V(2.375-2.62V) VDD option
- 32-pin SOIC/SOJ package
- Logic inputs latched at Power-On for frequency selection saving pins as Input/Output
- 48 MHz clock for USB support and 24 MHz clock for FD.

Pin Configuration



32-Pin SOIC/SOJ

Functionality

3.3V±10%,0-70°C

Crystal (X1, X2) = 14.31818 MHz

ADDRESS SELECT		CPU(1:12) (MHz)	BUS (1:6)MHz		48MHz	24MHz	REF	
FS2	FS1	FS0		BSEL=1	BSEL=0	1011111		n Di
0	0	0	50	25	32	48	24	REF
0	0	1	60	30	32	48	24	REF
0	1	0	66.8	33.4	32	48	24	REF
0	1	1	75.9	32	32	48	24	REF
1	0	0	55	27.5	32	48	24	REF
1	0	1	75.9	37.5	32	48	24	REF
1	1	0	83.3	41.7	32	48	24	REF
1	1	1	68.5	34.25	32	48	24	REF

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9169C-272RevC060297P



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Pin Descriptions

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION				
1	VDD	PWR	Power for device logic and crystal oscillator circuit and 14.318 MHz output.				
2			XTAL or external reference frequency input. This input includes XTAL load capacitance and feedback bias for a 12-16MHz crystal, nominally 14.31818MHz external crystal load of 30pF to GND recommended for VDD power on faste than 2.0ms.				
3	X2	OUT	XTAL output which includes XTAL load capacitance. External crystal load of 10pF to GND recommended for VDD power on faster than 2.0ms.				
4,11,20,26	GND	PWR	Ground for device logic.				
5	CPU(1)	OUT	Processor clock output which is a multiple of the input reference frequency.				
	FS0	IN	Frequency multiplier select pins. 350K internal pull up.				
6,7,9,10,15,16,17,18,19	CPU (2:5) (8:12)	OUT	Processor clock outputs which are a multiple of the input reference frequency.				
8	VDDC1	PWR	Power for CPU(1:6) output buffers only. Can be reduced VDD for 2.5V (2.375-2.62V) next generation processor clocks.				
12	CPU(6)	DataSheet OUT	Processor clock output which is a multiple of the input reference frequency internal pull up devices.				
12	FS1	IN	Frequency multiplier select pin. See shared pin description. 350K internal pull up.				
13	CPU(7)	OUT	Processor clock output which is a multiple of the input reference frequency internal pull up devices.				
15	FS2	IN	Frequency multiplier select pin. See shared pin description. 350K internal pull up.				
14	VDDC2	PWR	Power for CPU PLL, logic and CPU(7:12)output buffers. Must be nominal 3.3V (3.0 to 3.7V).				
21,22,24,25,27,28	BUS (1:6)	OUT	BUS clock outputs which are a multiple of the input reference clock.				
23	VDDB	PWR	Power for BUS clock buffers BUS(1:6).				
29	VDDF	PWR	Power for fixed clock buffer (48 MHz, 24 Mhz).				
30	24MHz	OUT	Fixed 24MHz clock (assuming a 14.31818MHz REF frequency).				
31	48MHz	OUT	Fixed 48MHz clock (assuming a 14.31818MHz REF frequency).				
32	REF		Fixed 14.31818MHz clock (assuming a 14.31818MHz REF frequency).				
32	BSEL	IN	Selection for synchronous or asynchronous bus clock operation. See shared pin programming description late in this data sheet for further explanation. 350K internal pull up.				

 \ast The internal pull up will vary from 350K $\,$ to 500K based on temperature



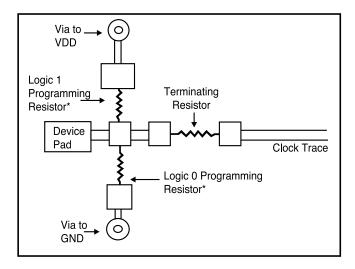
Shared Pin Operation -Input/Output Pins

Shared Pin Operation - Input/Output Pins 5, 12, 13 and 32 on the **ICS9169C-272** serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 4-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operation for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kilohm(10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period.

Figs. 1 and 2 show the recommended means of implementing this function. In Fig. 1 either one of the resistors is loaded onto the board (selective stuffing) to configure the device's internal logic. Figs. 2a and b provide eet4U.com a single resistor loading option where either solder spot tabs or a physical jumper header may be used.

These figures illustrate the optimal PCB physical layout options. These configuration resistors are of such a large ohmic value that they do not effect the low impedance clock signals. The layouts have been optimized to provide as little impedance transition to the clock signal as possible, as it passes through the programming resistor pad(s).



Test Mode Operation

The **ICS9169C-272** includes a production test verification mode of operation. This requires that the FS0 and FS1 pins be programmed to a logic high and the FS2 pin be programmed to a logic low(see Shared Pin Operation section). In this mode the device will output the following frequencies.

]	Frequency	
Ā	REF	
48	REF/2	
24	REF/4	
CPU	REF2	
DUS (1.6)	BSEL=1	REF/4
BUS (1:6)	BSEL = 0	REF/3

Note: REF is the frequency of either the crystal connected between the devices X1 and X2 or, in the case of a device being driven by an external reference clock, the frequency of the reference (or test) clock on the device's X1 pin.

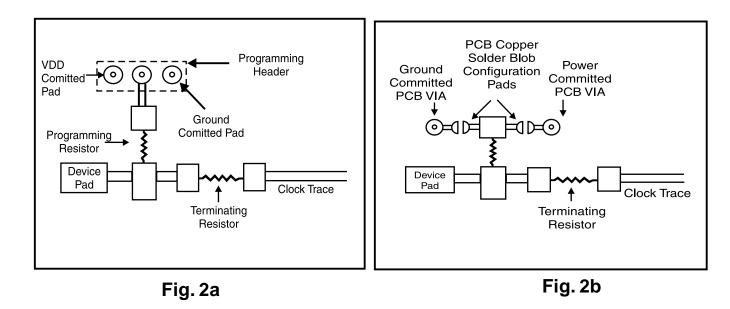
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(Resistors are surface mount devices shown schematically between 5.m. pads)

*use only one programming resistor

Fig. 1





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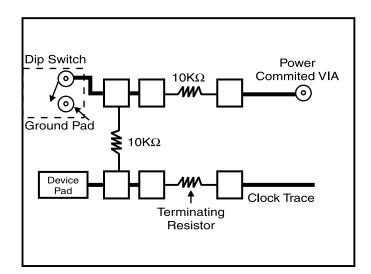


Fig. 3

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Technical Pin Function Descriptions

VDD

This is the power supply to the internal logic of the device as well as the following clock output buffers:

- A. REF clock output buffers
- B. BUS clock output buffers
- C. Fixed clock output buffers

This pin may be operated at any voltage between 3.0 and 5.5 volts. Clocks from the listed buffers that it supplies will have a voltage swing from ground to this level. For the actual guaranteed high and low voltage levels of these clocks, please consult the AC parameter table in this data sheet.

GND

This is the power supply ground return pin for the internal logic of the device as well as the following clock output buffers:

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- A. REF clock output buffers B. BUS clock output buffers
- C. CPU clock output buffers
 - D. Fixed clock output buffers

X1

This pin serves one of two functions. When the device is used with a crystal, X1 acts as the input pin for the reference signal that comes from the discrete crystal. When the device is driven by an external clock signal, X1 is the device' input pin for that reference clock. This pin also implements an internal crystal loading capacitor that is connected to ground. See the data tables for the value of the capacitor.

X2

This pin is used only when the device uses a Crystal as the reference frequency source. In this mode of operation, X2 is an output signal that drives (or excites) the discrete crystal. This pin also implements an internal crystal loading capacitor that is connected to ground. See the data tables for the value of the capacitor.

CPU

This pin is the clock output that drives processor and other CPU related circuitry that require clocks which are in tight skew tolerance with the CPU clock. The voltage swing of these clocks is controlled by that which is applied to the VDDC pins of the device. See note on VDDC (1:2). See the Functionality table at the beginning of this data sheet for a list of the specific frequencies that this clock operates at and the selection codes that are necessary to produce these frequencies.

BUS

This pin is the clock output that is intended to drive the

systems plug-in card bus. The voltage swing of these clocks is control-led by the supply that is applied to the VDD pin of the device. See the Functionality table at the beginning of this data sheet for a list of the specific frequencies that this clock operates at and the selection codes that are necessary to produce these frequencies.

FS0, FS1, FS2

These pins control the frequency of the clocks at the CPU, CPUL, BUS & SDRAM pins. See the Funtionality table at the beginning of this data sheet for a list of the specific frequencies that this clock operates at and the selection codes that are necessary to produce these frequencies. The device reads these pins at power-up and stores the programmed selection code in an internal data latch. (See programming section of this data sheet for configuration circuitry recommendations.

BSEL

This pin controls whether the BUS clocks will be synchronous (run at half the frequency) with the CPU and CPUL clocks or whether they will be asynchronous (run at a pre-programmed fixed frequency) clock rate. It is a DataSheet4shared pin and is pro grammed the same way as the frequency select pins.

VDDC (1:2)

These are the power supply pins for the CPU (1:6) and CPU (7:12) clock buffers. By separating the clock power pins, each group can receive the appropriate power decoupling and bypassing necessary to minimize EMI and crosstalk between the individual signals. VDDCL can be reduced to 2.5V VDD for advanced processor clocks, which will bring CPU (1:6) outputs at 0 to 2.5V output swings.

48 MHz

This is a fixed frequency clock that is typically used to drive Super I/O peripheral device needs.

24 MHz

This is a fixed frequency clock that is typically used to drive Keyboard controller clock needs.

REF

This is a fixed frequency clock that runs at the same frequency as the input reference clock (typically 14.31818 MHz) is and typically used to drive Video and ISA BUS requirements.

VDDB

This power pin supplies the BUS clock buffers.

VDDF

This power pin supplies the 48/24 MHz clocks.



Absolute Maximum Ratings

Supply Voltage	7.0 V
Logic Inputs	GND –0.5 V to $\ V_{DD}$ +0.5 V
Ambient Operating Temperature	$0^{\circ}C$ to $+70^{\circ}C$
Storage Temperature	-65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics at 3.3V

 $V_{DD} = 3.0 - 3.7 \text{ V}$, $T_A = 0 - 70^{\circ} \text{C}$ unless otherwise stated

DC Characteristics								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS		
Input Low Voltage	VIL		-	-	0.2Vdd	V		
Input High Voltage	VIH	DataSheet4U.com	0.7Vdd	-	-	V		
Input Low Current	IIL	VIN=0V	-28.0	-10.5	-	μΑ		
Input High Current	Іін	Vin = Vdd	-5.0	-	5.0	μΑ		
Output Low Current ¹	Iol	VOL = 0.8V; for CPU, BUS, REF	19.0	30.0	-	mA		
Output High Current ¹	Іон	VOL = 2.0V; for CPU, BUS, REF	-	-38.0	-16.0	mA		
Output Low Current ¹	Iol	VOL = 0.8V; for fixed CLKs	16.0	25.0	-	mA		
Output High Current ¹	Іон	VOL = 2.0V; for fixed CLKs	-	-30.0	-14.0	mA		
Output Low Voltage ¹	Vol	IOL = 10mA; for CPU, BUS, REF	-	0.3	0.4	V		
Output High Voltage ¹	Voh	IOH = -15 mA; for CPU, BUS, REF	2.4	2.8	-	V		
Output Low Voltage ¹	Vol	IOL = 8mA; for fixed CLKs	-	0.3	0.4	v		
Output High Voltage ¹	Voh	IOH = -8mA; for fixed CLKs	2.4	2.8	-	V		
Supply Current	Idd	@66.6 MHz; all outputs unloaded	-	90	180	mA		

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.

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Electrical Characteristics at 3.3V

 $V_{DD}=3.0-3.7\,V,\,T_A=0-70^\circ C$ unless otherwise stated

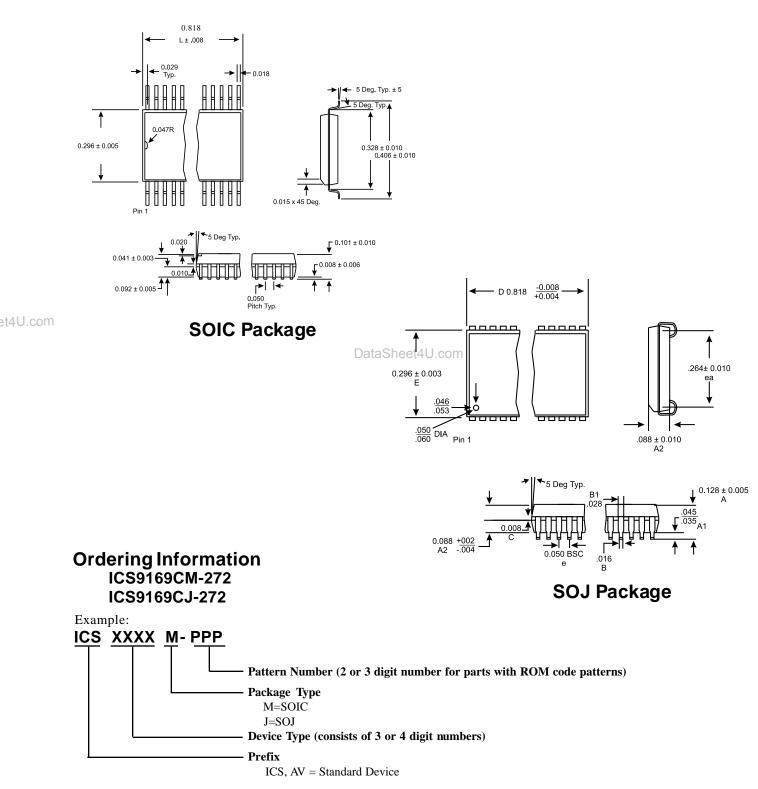
AC Characteristics							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	ТҮР	MAX	UNITS	
Rise Time ¹	T _{r1}	20pF load, 0.8 to 2.0V CPU & BUS	-	0.9	1.5	ns	
Fall Time ¹	Tf1	20pF load, 2.0 to 0.8V CPU & BUS	-	0.8	1.4	ns	
Rise Time ¹	T _{r2}	20pF load, 20% to 80% CPU & BUS	-	1.5	2.5	ns	
Fall Time ¹	T _{f2}	20pF load, 80% to 20% CPU & BUS	-	1.4	2.4	ns	
Duty Cycle ¹	Dt	20pF load @ VOUT=1.4V	45	50	60	%	
Jitter, One Sigma ¹	Tj1s1	CPU & BUS Clocks; Load=20pF, BSEL=1	-	50	150	ps	
Jitter, Absolute ¹	Tjab1	CPU & BUS Clocks; Load=20pF, BSEL=1	-250	-	250	ps	
Jitter, One Sigma ¹	Tj1s2	REF & Fixed CLKs; Load=20pF	-	1	3	%	
Jitter, Absolute ¹	Tjab2	REF & Fixed CLKs; Load=20pF	-5	2	5	%	
Input Frequency ¹	Fi	DataSheet4U.com	12.0	14.318	16.0	MHz	
Logic Input Capacitance ¹	Cin	Logic input pins	-	5	-	pF	
Crystal Oscillator Capacitance ¹	CINX	X1, X2 pins	-	18	-	pF	
Power-on Time ¹	ton	From VDD=1.6V to 1st crossing of 66.6 MHz VDD supply ramp < 40ms	-	2.5	4.5	ms	
Clock Skew ¹	T _{sk1}	CPU to CPU; Load=20pF; @1.4V	-	150	250	ps	
Clock Skew ¹	Tsk2	BUS to BUS; Load=20pF; @1.4V	-	150	250	ps	
Clock Skew ¹	T _{sk3}	CPU to BUS; Load=20pF; @1.4V (CPU is early)	1	2.6	4	ns	
Clock Skew ¹	Tsr4	CPU (@3.3V) to CPU (@2.5V) (2.5V CPU is late)		0.5	1	ns	

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